

RoHS Compliant Product
A suffix of "-C" specifies halogen free

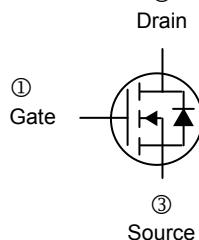
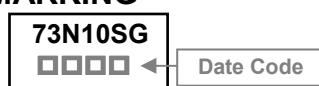
DESCRIPTION

The SSQ73N10SG is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications. The SSQ73N10SG meet the RoHS and Green Product with Function reliability approved.

FEATURES

- $R_{DS(on)} \leq 11\text{m}\Omega$ @ $V_{GS}=10\text{V}$
- $R_{DS(on)} \leq 14\text{m}\Omega$ @ $V_{GS}=4.5\text{V}$
- High speed power switching, Logic Level
- Enhanced Body diode dv/dt capability
- Enhanced Avalanche Ruggedness
- 100% UIS Tested, 100% R_g Tested
- TO-220 Package

MARKING



| REF. | Millimeter | | REF. | Millimeter | |
|------|------------|-------|------|------------|-----------|
| | Min. | Max. | | H | 2.54 BSC. |
| A | 9.96 | 10.36 | I | 2.04 | 2.92 |
| B | 14.7 | 16 | J | 3.745 | REF. |
| C | 2.74 | BSC. | K | 0.356 | 0.5 |
| D | 12.7 | 14.73 | L | 5.85 | 6.85 |
| E | 1.15 | 1.82 | M | 0.51 | 1.39 |
| F | 0.39 | 1.01 | G | 3.56 | 4.82 |

ABSOLUTE MAXIMUM RATINGS ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
|----------------------------------------------------|-----------------|-----------|-----------------------------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current (Silicon Limited) | I_D | 73 | A |
| $T_C=100^\circ\text{C}$ | | 52 | |
| Pulsed Drain Current | I_{DM} | 190 | A |
| Avalanche Energy, Single Pulse, @ $L=0.1\text{mH}$ | E_{AS} | 22 | mJ |
| Power Dissipation | P_D | 125 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 ~ 175 | $^\circ\text{C}$ |
| Thermal Resistance Ratings | | | |
| Maximum Thermal Resistance Junction-Ambient | $R_{\theta JA}$ | 50 | $^\circ\text{C} / \text{W}$ |
| Maximum Thermal Resistance Junction-Case | $R_{\theta JC}$ | 1.2 | |

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test conditions |
|-----------------------------------|----------------------------|------|------|-----------|---------------|------------------------------------------------------------------------------------------------|
| Drain-Source Breakdown Voltage | BV_{DSS} | 100 | - | - | V | $\text{V}_{GS}=0$, $I_D=250\mu\text{A}$ |
| Gate Threshold Voltage | $\text{V}_{GS(\text{th})}$ | 1.4 | 1.9 | 2.4 | V | $\text{V}_{DS}=\text{V}_{GS}$, $I_D=250\mu\text{A}$ |
| Forward Transfer conductance | g_{fs} | - | 60 | - | S | $\text{V}_{DS}=5\text{V}$, $I_D=20\text{A}$ |
| Gate-Source Leakage Current | I_{GSS} | - | - | ± 100 | nA | $\text{V}_{GS}=\pm 20\text{V}$ |
| Drain-Source Leakage Current | I_{DSS} | - | - | 1 | μA | $\text{V}_{DS}=100\text{V}$, $\text{V}_{GS}=0$ |
| $T_J=100^\circ\text{C}$ | | - | - | 100 | | |
| Static Drain-Source On-Resistance | $R_{DS(\text{ON})}$ | - | 9 | 11 | mΩ | $\text{V}_{GS}=10\text{V}$, $I_D=20\text{A}$ |
| | | - | 11 | 14 | mΩ | $\text{V}_{GS}=4.5\text{V}$, $I_D=20\text{A}$ |
| Total Gate Charge | Q_g | - | 29 | - | nC | $\text{V}_{GS}=10\text{V}$ |
| Total Gate Charge | Q_g | - | 14 | - | | $\text{V}_{GS}=4.5\text{V}$ |
| Gate-Source Charge | Q_{gs} | - | 5 | - | | $I_D=14\text{A}$ |
| Gate-Drain ("Miller") Change | Q_{gd} | - | 5 | - | | $\text{V}_{DD}=50\text{V}$ $\text{V}_{GS}=10\text{V}$ |
| Turn-on Delay Time | $T_{d(on)}$ | - | 8 | - | nS | $\text{V}_{DD}=50\text{V}$ $I_D=14\text{A}$ $\text{V}_{GS}=10\text{V}$ $R_G=10\Omega$ |
| Rise Time | T_r | - | 3 | - | | |
| Turn-off Delay Time | $T_{d(off)}$ | - | 26 | - | | |
| Fall Time | T_f | - | 4 | - | | |
| Input Capacitance | C_{iss} | - | 2275 | - | pF | $\text{V}_{GS}=0$ $\text{V}_{DS}=50\text{V}$ $f=1.0\text{MHz}$ |
| Output Capacitance | C_{oss} | - | 162 | - | | |
| Reverse Transfer Capacitance | C_{rss} | - | 7.9 | - | | |
| Source-Drain Diode | | | | | | |
| Forward On Voltage | V_{SD} | - | 0.9 | 1.2 | V | $I_F=20\text{A}$, $\text{V}_{GS}=0$ |
| Reverse Recovery Time | T_{rr} | - | 33 | - | nS | $V_R=50\text{V}$, $I_F=12\text{A}$, $dI/dt=500\text{A}/\mu\text{s}$ |
| Reverse Recovery Charge | Q_{rr} | - | 157 | - | nC | |

TYPICAL CHARACTERISTICS CURVE

Fig 1. Typical Output Characteristics

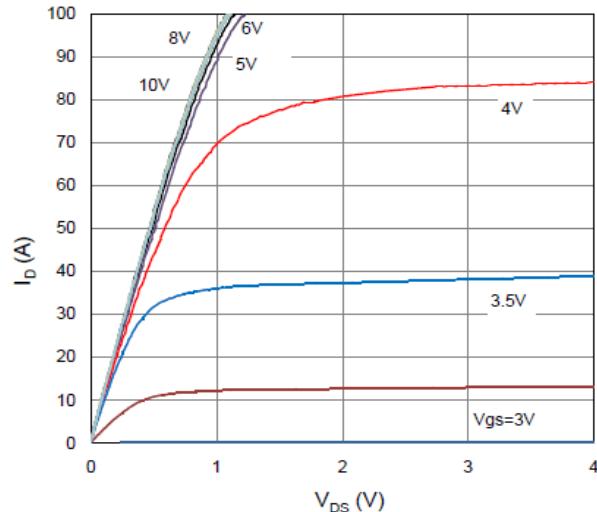


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

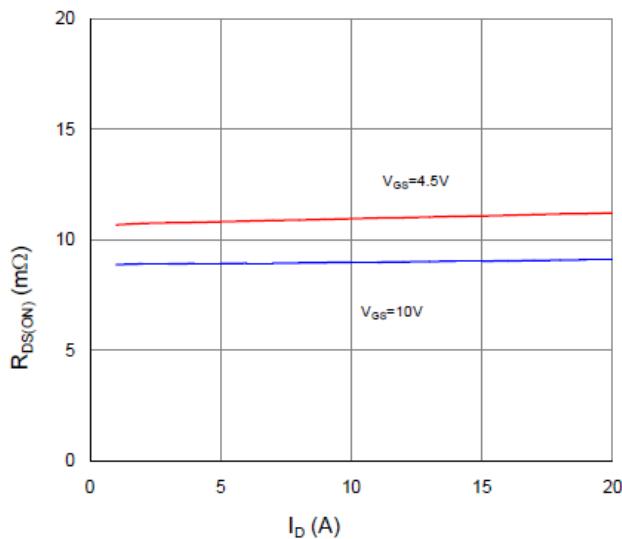


Figure 5. Typical Transfer Characteristics

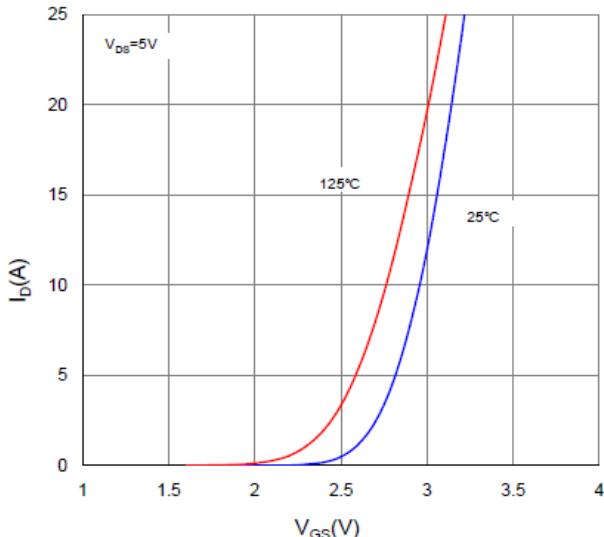


Figure 2. On-Resistance vs. Gate-Source Voltage

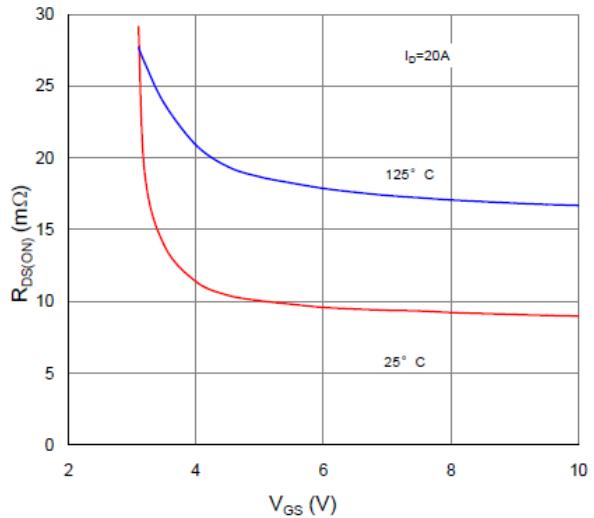


Figure 4. Normalized On-Resistance vs. Junction Temperature

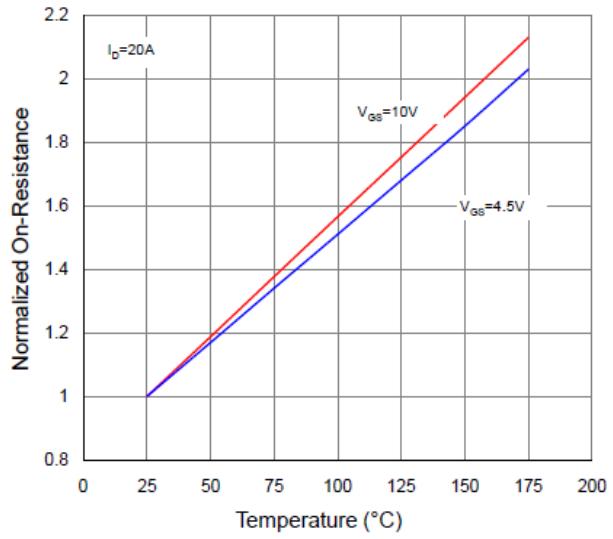
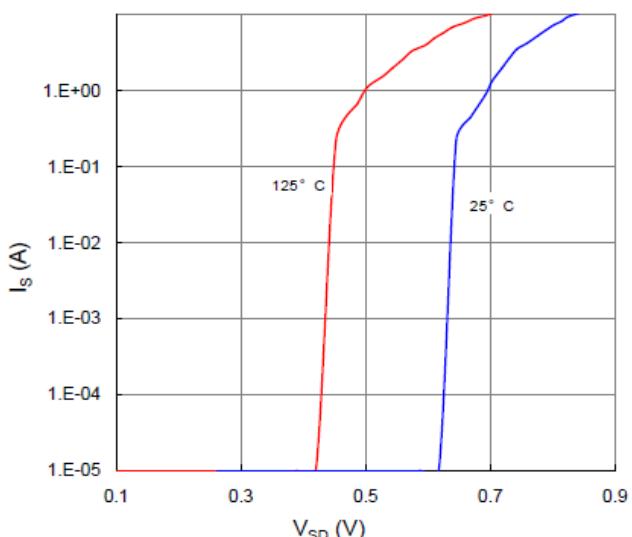


Figure 6. Typical Source-Drain Diode Forward Voltage



TYPICAL CHARACTERISTICS CURVE

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

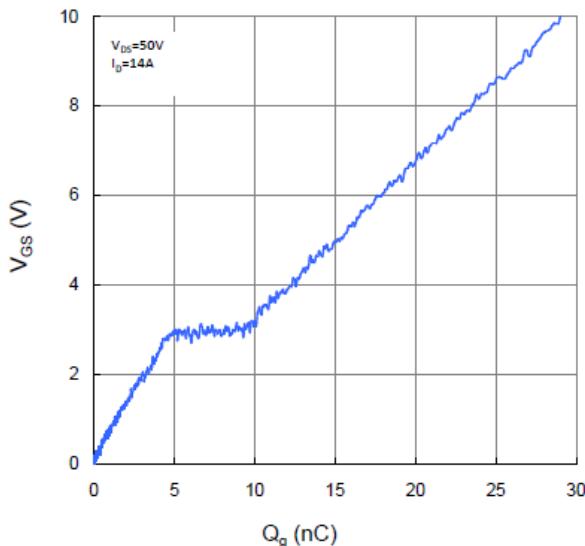


Figure 9. Maximum Safe Operating Area

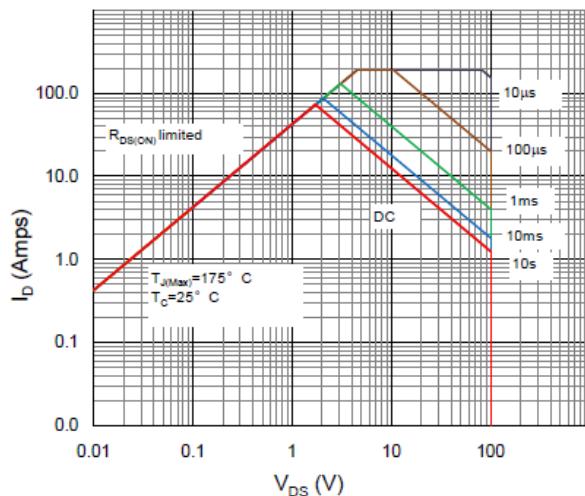


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient

